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November 1992 Revised April 2005

74VHC245 Octal Bidirectional Transceiver with 3-STATE Outputs

General Description

The VHC245 is an advanced high speed CMOS octal bus transceiver fabricated with silicon gate CMOS technology. It achieves high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation. The VHC245 is intended for bidirectional asynchronous communication between data busses. The direction of data transmission is determined by the level of the T/\overline{R} input. The enable input can be used to disable the device so that the busses are effectively isolated. All inputs are equipped with protection circuits against static discharge.

Features

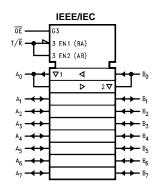
- High Speed: t_{PD} = 4.0 ns (typ) at V_{CC} = 5V
- High Noise Immunity: V_{NIH} = V_{NIL} = 28% V_{CC} (Min)
- Power Down Protection is provided on all inputs
- Low Noise: V_{OLP} = 0.9V (typ)
- Low Power Dissipation: $I_{CC} = 4 \mu A \text{ (Max) } @ T_A = 25 ^{\circ}\text{C}$
- Pin and Function Compatible with 74HC245

Ordering Code:

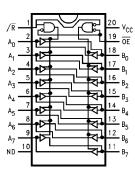
Order Number	Package Number	Package Description					
74VHC245M	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide					
74VHC245SJ	M20D	Pb-Free 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide					
74VHC245MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide					
74VHC245N	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide					

Surface mount packages are also available on Tape and Reel. Specify by appending the suffix letter "X" to the ordering code. Pb-Free package per JEDEC J-STD-020B.

Logic Symbol



Connection Diagram



Pin Description

Pin	Description						
Names							
ŌĒ	Output Enable Input						
T/R	Transmit/Receive Input						
A ₀ -A ₇	Side A Inputs or 3-STATE Outputs						
B ₀ -B ₇	Side B Inputs or 3-STATE Outputs						

Truth Table

Inputs		Outputs
OE T/R		
Г	L	Bus B Data to Bus A
L	Н	Bus A Data to Bus B
Н	Χ	HIGH-Z State

 $\label{eq:High-voltage} \begin{array}{lll} \mbox{H = HIGH Voltage Level} & \mbox{X = Immaterial} \\ \mbox{Any unused bus terminals during HIGH-Z State must be held HIGH or LOW.} \end{array}$

Absolute Maximum Ratings(Note 1)

 $\begin{array}{ll} \mbox{Supply Voltage (V$_{CC}$)} & -0.5 \mbox{V to } +7.0 \mbox{V} \\ \mbox{DC Input Voltage (V$_{IN}$) (T/\overline{R}, $\overline{\mbox{OE}}$)} & -0.5 \mbox{V to } 7.0 \mbox{V} \end{array}$

 $\begin{array}{lll} \text{DC Output Voltage (V_{OUT})} & -0.5 \text{V to V}_{CC} + 0.5 \text{V} \\ \text{Input Diode Current (I}_{IK}) \text{ (T/R}, \overline{\text{OE}}) & -20 \text{ mA} \\ \text{Output Diode Current (I}_{OK}) & \pm 20 \text{ mA} \\ \text{DC Output Current (I}_{OUT}) & \pm 25 \text{ mA} \\ \end{array}$

DC V $_{\rm CC}$ /GND Current (I $_{\rm CC}$) ± 75 mA Storage Temperature (T $_{\rm STG}$) $-65^{\circ}{\rm C}$ to $+150^{\circ}{\rm C}$

Lead Temperature (T_L)

(Soldering, 10 seconds) 260°C

Recommended Operating Conditions (Note 2)

 $\begin{array}{lll} \text{Supply Voltage (V}_{\text{CC}}) & 2.0 \text{V to } 5.5 \text{V} \\ \text{Input Voltage (V}_{\text{IN}})(\text{T/R}, \overline{\text{OE}}) & 0 \text{V to } 5.5 \text{V} \\ \text{Output Voltage (V}_{\text{OUT}}) & 0 \text{V to V}_{\text{CC}} \\ \text{Operating Temperature (T}_{\text{OPR}}) & -40 ^{\circ}\text{C to } +85 ^{\circ}\text{C} \end{array}$

Input Rise and Fall Time (t_r, t_f)

$$\begin{split} \text{V}_{\text{CC}} = 3.3 \text{V} \pm 0.3 \text{V} & 0 \sim 100 \text{ ns/V} \\ \text{V}_{\text{CC}} = 5.0 \text{V} \pm 0.5 \text{V} & 0 \sim 20 \text{ ns/V} \end{split}$$

Note 1: Absolute Maximum Ratings are values beyond which the device may be damaged or have its useful life impaired. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation outside databook specifica-

Note 2: Unused inputs or I/O pins must be held HIGH or LOW. They may not float

DC Electrical Characteristics

Symbol	Parameter	V _{CC}	T _A = 25°C		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions			
Symbol	Farameter	(V)	Min	Тур	Max	Min	Max	Onits	Conditions		
V _{IH}	HIGH Level	2.0	1.50			1.50		V			
	Input Voltage	3.0 – 5.5	0.7 V _{CC}			0.7 V _{CC}		V			
V _{IL}	LOW Level	2.0			0.50		0.50	V			
	Input Voltage	3.0 – 5.5			$0.3\mathrm{V}_{\mathrm{CC}}$		$0.3 V_{\rm CC}$	V			
V _{OH}	HIGH Level	2.0	1.9	2.0		1.9			$V_{IN} = V_{IH}$ $I_{OH} = -50 \mu A$		
	Output Voltage	3.0	2.9	3.0		2.9		V	or V _{IL}		
		4.5	4.4	4.5		4.4					
		3.0	2.58			2.48		V	I _{OH} = -4 mA		
		4.5	3.94			3.80		V	I _{OH} = -8 mA		
V _{OL}	LOW Level	2.0		0.0	0.1		0.1		$V_{IN} = V_{IH}$ $I_{OL} = 50 \mu A$		
	Output Voltage	3.0		0.0	0.1		0.1	V	or V _{IL}		
		4.5		0.0	0.1		0.1				
		3.0			0.36		0.44	V	I _{OL} = 4 mA		
		4.5			0.36		0.44	V	$I_{OL} = 8 \text{ mA}$		
I _{OZ}	3-STATE Output								V _{IN} = V _{CC} or GND		
	Off-State Current	5.5			± 0.25		± 2.5	μΑ	$V_{OUT} = V_{CC}$ or GND		
									$V_{IN} \overline{OE} = V_{IH} \text{ or } V_{IL}$		
I _{IN}	Input Leakage				±0.1		±1.0	μА	V _{IN} = 5.5V or GND		
(T/R, OE)	Current										
Icc	Quiescent Supply Current	5.5			4.0		40.0	μА	V _{IN} = V _{CC} or GND		

Noise Characteristics

Symbol	Parameter	v _{cc}	T _A = 25°C		Units	Conditions		
- Cymbol	T drameter	(V)	Тур	Limits	011110			
V _{OLP}	Quiet Output Maximum	5.0	0.9	1.2	V	C _L = 50 pF		
(Note 3)	Dynamic V _{OL}							
V _{OLV}	Quiet Output Minimum	5.0	-0.9	-1.2	V	C _L = 50 pF		
(Note 3)	Dynamic V _{OL}							
V _{IHD}	Minimum HIGH Level	5.0		3.5	V	C _L = 50 pF		
(Note 3)	Dynamic Input Voltage							
V _{ILD}	Maximum LOW Level	5.0		1.5	V	C _L = 50 pF		
(Note 3)	Dynamic Input Voltage							

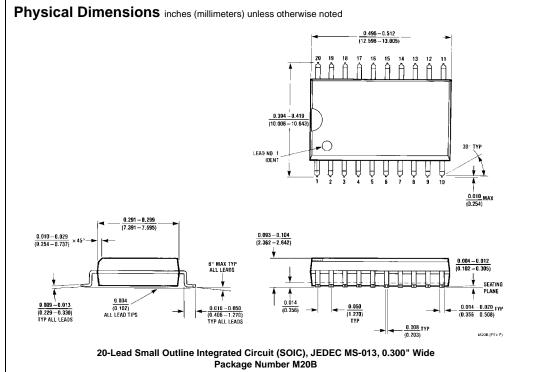
Note 3: Parameter guaranteed by design.

AC Electrical Characteristics

Symbol	Parameter	v _{cc}	$T_A = 25^{\circ}C$			T _A = -40°	C to +85°C	Units	Conditions	
		(V)	Min	Тур	Max	Min	Max	Units	Conc	11110113
t _{PLH}	Propagation Delay	3.3 ± 0.3		5.8	8.4	1.0	10.0			$C_{L} = 15 pF$
t _{PHL}	Time			8.3	11.9	1.0	13.5	ns		C _L = 50 pF
		5.0 ± 0.5		4.0	5.5	1.0	6.5	ns		C _L = 15 pF
				5.5	7.5	1.0	8.5	115		$C_L = 50 pF$
t _{PZL}	3-STATE Output	3.3 ± 0.3		8.5	13.2	1.0	15.5	ns	C _L = 15 pF	
t_{PZH}	Enable Time			11.0	16.7	1.0	19.0	113	$R_1 = 1 k\Omega$	$C_L = 50 pF$
		5.0 ± 0.5		5.8	8.5	1.0	10.0	ns		C _L = 15 pF
				7.3	10.6	1.0	12.0	115		$C_L = 50 pF$
t _{PLZ}	3-STATE Output	3.3 ± 0.3		11.5	15.8	1.0	18.0	ns	$R_L = 1 k\Omega$	$C_L = 50 pF$
t_{PHZ}	Disable Time	5.0 ± 0.5		7.0	9.7	1.0	11.0	113		$C_{L} = 50 \text{ pF}$
t _{OSLH}	Output to Output	3.3 ± 0.3			1.5		1.5	ns		$C_L = 50 pF$
toshl	Skew	5.0 ± 0.5			1.0		1.0	113		$C_L = 50 pF$
C _{IN}	Input Capacitance			4	10		10	pF	V _{CC} = Ope	n
$(T/R, \overline{OE})$										
C _{I/O}	Output Capacitance			8				pF	V _{CC} = 5.0\	/
C _{PD}	Power Dissipation			21				pF	(Note 5)	
	Capacitance									

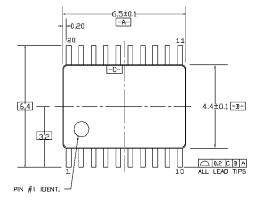
 $\textbf{Note 4:} \ \text{Parameter guaranteed by design.} \ t_{\text{OSLH}} = |t_{\text{PLH max}} - t_{\text{PLH min}}|; \ t_{\text{OSHL}} = |t_{\text{PHL max}} - t_{\text{PHL min}}|$

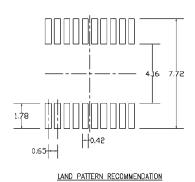
Note 5: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I_{CC} (opr.) = C_{PD} * V_{CC} * f_{IN} + I_{CC} /8 (per Bit).



Physical Dimensions inches (millimeters) unless otherwise noted (Continued) 12.6±0.10 0.40 TYP --A-5.3±0.10 9.27 TYP 7.8 -B-3.9 0.2 C B A ALL LEAD TIPS 10 PIN #1 IDENT.-0.6 TYP 1.27 TYP LAND PATTERN RECOMMENDATION ALL LEAD TIPS SEE DETAIL A 0.1 C 1.8±0.1 -C-L _{0.15±0.05} 0.15-0.25 -1.27 TYP 0.35-0.51 ⊕ 0.12 **(** C A DIMENSIONS ARE IN MILLIMETERS GAGE PLANE 0.25 NOTES: A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998. B. DIMENSIONS ARE IN MILLIMETERS. C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS. 0.60±0.15 SEATING PLANE 1.25 -M20DRevB1 DETAIL A Pb-Free 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide Package Number M20D

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)





1.2 TO.3 C TIPS

1.2 TO.50 + 0.15

0.1±0.05

0.1±0.05

0.15

0.1±0.05



DIMENSIONS ARE IN MILLIMETERS

NOTES:

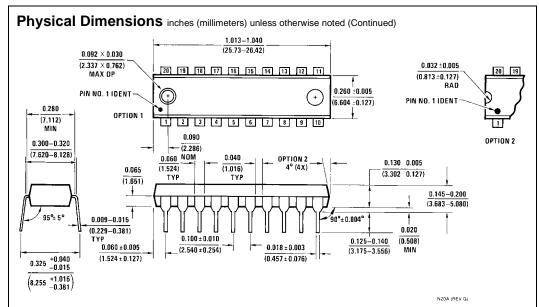
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- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLDS FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

0 - 8°7 GAGE PLANE -0.6±0.1- SEATING PLANE R0.09min

DETAIL A

MTC20REVD1

20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC20



20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N20A

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